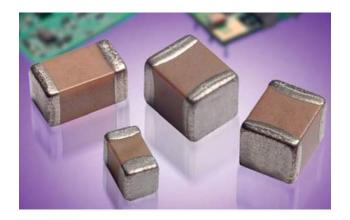
General Specifications



RoHS



X7R formulations are called "temperature stable" ceramics and fall into EIA Class II materials. X7R is the most popular of these intermediate dielectric constant materials. Its temperature variation of capacitance is within ±15% from -55°C to +125°C. This capacitance change is non-linear.

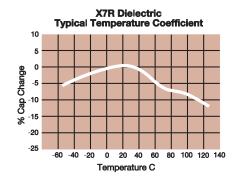
Capacitance for X7R varies under the influence of electrical operating con-ditions such as voltage and frequency.

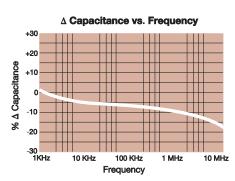
X7R dielectric chip usage covers the broad spectrum of industrial applications where known changes in capacitance due to applied voltages are acceptable.

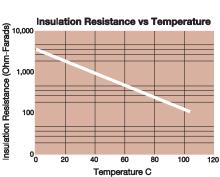
PART NUMBER (see page 2 for complete part number explanation)

0805	<u>5</u>	<u>C</u>	103	<u>M</u>	<u>A</u>	<u>T</u>	<u>2</u>	<u>A</u>
Size (L" x W")	Voltage 4V = 4 6.3V = 6 10V = Z 16V = Y 25V = 3 50V = 5 100V = 1 200V = 2 500V = 7	Dielectric X7R = C		Capacitance Tolerance J = ± 5%* K = ±10% M = ± 20% *≤1µF only, contact factory for additional values		Terminations T = Plated Ni and Sn 7 = Gold Plated* Z= FLEXITERM®** *Optional termination **See FLEXITERM® X7R section	Packaging 2 = 7" Reel 4 = 13" Reel Contact Factory For Multiples	Special Code A = Std. Product

NOTE: Contact factory for availability of Termination and Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.

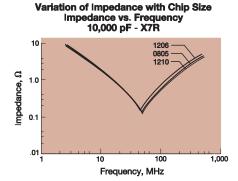


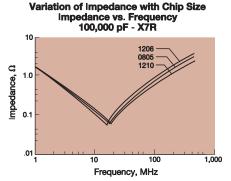




Impedance vs. Frequency 1,000 pF vs. 10,000 pF - X7R 0805 10.00 pF 10,000 pF 10,000 pF 10,000 pF

variation of impedance with Cap Value







Specifications and Test Methods

Parame	eter/Test	X7R Specification Limits	Measuring Conditions							
Operating Tem	perature Range	-55°C to +125°C	Temperature C	ycle Chamber						
Сарас	citance	Within specified tolerance	Freq.: 1.0 k	νHz + 10%						
Dissipati	ion Factor	≤ 10% for ≥ 50V DC rating≤ 12.5% for 25V DC rating ≤ 12.5% for 25V and 16V DC rating ≤ 12.5% for ≤ 10V DC rating	Voltage: 1.0							
Insulation	Resistance	100,000MΩ or 1000MΩ - μ F, whichever is less	_	Charge device with rated voltage for 120 ± 5 secs @ room temp/humidity						
Dielectri	c Strength	No breakdown or visual defects	Charge device with 250 1-5 seconds, w/charge limited to 50 Note: Charge device voltage for 50	and discharge current o mA (max) with 150% of rated						
	Appearance	No defects	Deflection							
Resistance to	Capacitance Variation	≤ ±12%	Test Time:	30 seconds 1mm/sec						
Flexure Stresses	Dissipation Factor	Meets Initial Values (As Above)		V IIIIIVsec						
	Insulation Resistance	≥ Initial Value x 0.3		0 mm						
Solde	rability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutection for 5.0 ± 0.							
	Appearance	No defects, <25% leaching of either end terminal								
	Capacitance Variation	≤ ±7.5%	Dip device in eutectic solder at 260°C for 60second							
Resistance to Solder Heat	Dissipation Factor	Meets Initial Values (As Above)	Store at room temperatur measuring elect							
	Insulation Resistance	Meets Initial Values (As Above)								
	Dielectric Strength	Meets Initial Values (As Above)								
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes						
	Capacitance Variation	≤ ±7.5%	Step 2: Room Temp	≤ 3 minutes						
Thermal Shock	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes						
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes						
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles 24 ± 2 hours at ro	and measure after oom temperature						
	Appearance	No visual defects	Charge device with 1.5	rated voltage (≤ 10V) in						
	Capacitance Variation	≤ ±12.5%	Charge device with 1.5 rated voltage (≤ 10V) in test chamber set at 125°C ± 2°C for 1000 hours (+48, -0)							
Load Life	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	If RV > 10V then Life Te but there are exceptions							
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	further details	on exceptions)						
	Dielectric Strength	Meets Initial Values (As Above)	Remove from test chamb temperature for 24 ± 2 h							
	Appearance	No visual defects	Store in a test chamb	or set at 8500 ± 2007						
	Capacitance Variation	≤ ±12.5%	85% ± 5% relative hull (+48, -0) with rate	midity for 1000 hours						
Load Humidity	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	Remove from chambel							
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	temperature ar	nd humidity for						
	Dielectric Strength	Meets Initial Values (As Above)		g.						





PREFERRED SIZES ARE SHADED

																ш	ш																	
SIZE		0101*		0201				0402			0603						0805						1206											
Soldering		Reflow Only		Reflow Only				Reflow/Wave				Reflow/Wave					Reflow/Wave						Reflow/Wave											
Packaging	9	Paper/Embossed		All Paper					All Paper				All Paper							Pap	oer/Em	bossed	i		Paper/Embossed									
	mm 0.40 ± 0.02 0.60 ± 0.03					1.	.00 ± 0.	10			1.60 ± 0.15						2.01 ± 0.20						3.20 ± 0.20											
(L) Length	(in)	(0.016 ± 0.0008)	l	(0.0)	24 ± 0.0	001)			(0.0	040 ± 0.	004)		l		((0.063 ±	0.006)			(0.079 ± 0.008)						(0.126 ± 0.008)								
(W) Width	mm	0.20 ± 0.02	!		30 ± 0.0			!		.50 ± 0.			!			0.81 ±				•			1.25 ±				1.60 ± 0.20							
(11) 111001	(in)	(0.008 ± 0.0008)			11 ± 0.0					$020 \pm 0.$						0.032 ±							0.049 ±								63 ± 0.0			
(t) Terminal	mm	0.10± 0.04	ļ .		15 ± 0.0			ļ .		.25 ± 0.			ļ .			0.35 ±				ļ .			0.50 ±				ļ				50 ± 0.2			
(7)	(in)	(0.004 ± 0.0016)			06 ± 0.0		,			010 ± 0.		,		,		0.014 ±				(0.020 ± 0.010)						(0.020 ± 0.010)								
Cap 100	WVDC 0 101	16 B	6.3 A	10 A	16	25 A	50	6.3	10	16 C	25 C	50 C	6.3	10	16	25	50 G	100 G	200 G	6.3	10	16	25	50	100	200	6.3	10	16	25	50	100	200	500
(pF) 150		B	A	A	A	A	A		\vdash	C	C	C		+	\vdash	\vdash	G	G	G		\vdash	\vdash						\vdash	\vdash	\vdash	\vdash	 	\vdash	\vdash
220		В	A	A	Α	A	A			С	С	С			т		G	G	G	Е	Е	Е	Е	Е	Е	Е		-	т					$\overline{}$
330		В	Α	Α	Α	Α	Α			С	С	С					G	G	G		J	J	J	J	J	J								K
470		В	Α	Α	Α	Α	Α			С	С	С					G	G	G		J	J	J	J	J	J		\Box						K
680		В	A	A	Α	A	_			С	С	С	<u> </u>	1	<u> </u>	<u> </u>	G	G	G		J	J	J	J	J	J	<u> </u>	ـــــ	igspace				\vdash	K
1000		B B	A A	A	A	A	_	⊢	C	C	C	C	_	\vdash	₩	-	G	G G	G		J	J	J	J	J	J	-	J		-		J		K M
2200		В	A	A	A	A		\vdash	С	C	C	C		+	\vdash	\vdash	G	G		\vdash	J	.1	J		J	J		J	J	J	J	J	J	M
3300			A	A	A	A			С	C	С	C			\vdash		G	G			J	J	J	J	J	J		J	J	J	J	J	J	M
4700			Α	Α	Α	Α			С	С	С	С			т		G	G			J	J	J	J	J	J		J	J	J	J	J	J	M
6800	0 682		A	Α	Α	Α			С	С	С	С					G	G			J	J	J	J	J	J		J	J	J	J	J	J	Р
Cap 0.01			A	Α	Α	Α			С	С	С	С				G	G	G	J		J	J	J	J	J	J		J	J	J	J	J	J	Р
(μF) 0.015			_	-					С	С	С	С		-	<u> </u>	G	G	G	J		J	J	J	J	J	J		J	J	J	J	J	М	Q
0.022			⊢	\vdash	\vdash	\vdash	\vdash	⊢	C	C	C	C	-	\vdash	₩	G	G	G		⊢	J	J	J	J -	J N	N N		J	J	J	J	J	M	Q
0.033			-	+					C	C	C	C		+	G	G	G	J		┢	J	J	J	J	N N	N N		J	J	J	J	J	M	u
0.068			\vdash	+				H	С	C	С	C			G	G	G	J		\vdash	J	J	J	J	N	N		J	Ĵ	J	J	J	P	
0.1			 	1					С	С	С	С		G	G	G	G	J			J	J	J	J	N	N	ì	J	J	J	J	Р	Р	
0.15	5 154												G	G	G	G					J	٦	J	N	N			J	J	J	J	Q		
0.22									С	С	С		G	G	J	J	J				J	J	N	N	N			J	J	J	J	Q		
0.33			┞	-		_		_		_		-	J	J	J	J				_	N	N	N	N	N			J	J	M	P	Q		—
0.47			├	-		-		С	С	-	\vdash	-	J	J	J	J	J		-	⊢	N N	N N	N N	N	N		\vdash	M	M	M Q	P	Q	<u> </u>	
1.0			Η-	+		\vdash		С		\vdash	\vdash	+	J	J	J	J.	J.		-		N N	N N	N	N		-	\vdash	M	M	Q	Q	Q	-	-
2.2			 	t		\vdash				1		t	J	J	J	,	-			\vdash	P	P	P	P**			t	Q	Q	Q	Q	Q**		-
4.7			İ			İ			Т	T			J								Р	Р	Р			i –		Q	Q	Q	Q		$\overline{}$	
10																				Р	Р	Р						Q	Q	Х	Х			
22																											Q	Q	Q					
47		ļ	┞—	₩	<u> </u>	<u> </u>	-	┞	├	-	⊢	1	┞—	₩	₩.	<u> </u>	├		-	┞	├	\vdash				<u> </u>	Q	Q	Х		ш	<u> </u>	⊢	—
100	WVDC	16	6.3	10	16	25	50	6.3	10	16	25	50	6.3	10	16	25	50	100	200	6.3	10	16	25	50	100	200	Q 6.3	10	16	25	50	100	200	500
-	SIZE	0101	0.3	10	0201	25	30	0.3	_	0402	_	30	0.3	10	1.0	060	_	100	200	0.3	10	10	080		100	200	0.3	10	10	_	1206	100	200	300
	0101			0201					3402						000	,,,						080								1200				

Letter	Α	В	С	E	G	J	K	M	N	Р	Q	X	Y	Z				
Max.	0.33	0.22	0.56	0.71	0.90	0.94	1.02	1.27	1.40	1.52	1.78	2.29	2.54	2.79				
Thickness	(0.013)	(0.009)	(0.022)	(0.028)	(0.035)	(0.037)	(0.040)	(0.050)	(0.055)	(0.060)	(0.070)	(0.090)	(0.100)	(0.110)				
			PAF	PER			EMBOSSED											

PAPER and EMBOSSED available for 01005

NOTE: Contact factory for non-specified capacitance values

*EIA 01005

**Contact Factory for Specifications



Capacitance Range

PREFERRED SIZES ARE SHADED

	SIZE					1210)					1	812				1825				222	0			2225	5	
	Solderii	20			R	eflow C	nly			Reflow Only							Reflow Only			Reflow Only						Only	
	Packagi		+				ossed			All Embossed							Embos		,						All Embosse		
		mm	1			3.30 ± 0							± 0.30	u			.50 ± 0.3		All Embossed 5.70 ± 0.40						5.72 ± 0.25		
(L) Ler	ngtn	(in.)				.130± 0.							± 0.012	!)			177 ± 0.0				225 ± 0.		225 ± 0.				
(W) W	idth	mm				2.50 ± 0							± 0.20				.40 ± 0.4				.00 ± 0.				.25		
		(in.)	_			0.098 ± 0							± 0.008 ± 0.36	5)		_	252 ± 0. .61 ± 0.				197 ± 0. .64 ± 0.				.010)		
(t) Terr	minal	(in.)											± 0.30 + ± 0.014	!)			01 ± 0.0				.04 ± 0. 025 ± 0.				0.64 ± 0. 025 ± 0.		
	٧	VVDC	10	16	25	50	100	200	500	16	25	50	100	200	500	50	100	200	25	50	100	200	500	50	100	200	
Сар	100	101																			ı	1				_	
(pF)	150	151																				>	*		W		
	220 330	221 331	+																	<u> </u>		<u> </u>		$\overline{}$	\searrow		
	470	471								\vdash					_	\vdash			_	_	. 1)	ノ、エァ	г –	
	680	681																			'	_					
	1000	102																				`				_	
	1500	152	J	J	J	J	J	J	М														1				
	2200	222	J	J	J	J	J	J	М																	_	
	3300 4700	332 472	J	J	J	J	J	J	M M	_						_					<u> </u>	-	\vdash			+-	
	6800	682	J	J	J	J	J.I	J	M														\vdash			\vdash	
Сар	0.01	103	J	J	J	J	J	J	M		K	K	K	K	K	М	М	М		Х	Х	Х	Х	M	Р	Р	
(µF)	0.015	153	J	J	J	J	J	J	Р		K	K	K	K	Р	М	М	M		X	X	X	Х	M	Р	Р	
	0.022	223	J	J	J	J	J	J	Q		K	K	K	K	Р	М	М	М		Х	Х	Х	Х	M	Р	Р	
	0.033	333	J	J	J	J	J	J	Q		K	K	K	K	Х	М	M	M		Х	Х	Х	Х	M	Р	Р	
	0.047	473	J	J	J	J	J	J	Q		K	K	K	K	Z	M	M	M		X	X	X	X	M	P P	Р	
	0.058	683 104	J	J	J	J	J	M M	Q X		K K	K K	K K	K K	Z Z	M M	M M	M M		X	X	X	X	M M	P	P P	
-	0.15	154		J	J	J	M	Z	^		K	K	K	P	Z	M	M	M		X	X	X	X	M	Р	X	
	0.22	224		J	J	J	P	Z			K	K	K	P	Z	M	M	M		X	X	X	X	M	P	X	
	0.33	334	J	J	J	J	Q				K	K	M	Х		М	М			Х	Х	Х	Х	М	Р	Х	
	0.47	474	M	М	М	М	Q				K	K	Р	Χ		М	М			Х	Х	Х	Х	M	Р	Х	
	0.68	684		М	P	X	X				М	М	Q	_		M	P			X	X		\vdash	M	P	X	
	1.0	105 155	N N	N N	P Z	X Z	Z			\vdash	M Z	M Z	X Z	Z		M Q	Р			X	X		+-	M M	P X	Z	
	2.2	225	X	X	Z	Z	Z				Z	Z	Z			Q				X	X		\vdash	M	X	Z	
	3.3	335		X	Z	Z	Z				Z	Z	Z							X	Z						
	4.7	475	Z	Z	Z	Z					Z	Z								Х	Z						
	10	106	Z	Z	Z	Z				Z										Z	Z					\perp	
	22	226		Z	Z		-			<u> </u>									Z			-	$\vdash \vdash$		<u> </u>	-	
	47 100	476 107	Z																				\vdash		<u> </u>	+	
			10	16	25	50	100	200	500	16	25	50	100	200	500	50	100	200	25	50	100	200	500	50	100	200	
SIZE		1.0			1210		200	000				812	200	000	- 00	1825	200		- 00	222		000		222			
	0.22					1210	•					•	<u> </u>				1020		2220								
	Letter		Α	E	_	С		Е		-	J		K		vI .	N		Р		Q	Х		Υ		Z		
	Max. Thickness	s (0.33 (0.013)	0.22 0.56 (0.009) (0.022)					90	0.94		1.02 (0.040)		27 050)	1.40		1.52 (0.060)	1.78 (0.070)		2.29 (0.090)		2.54 (0.100)					
L		PAPER														EMBOSSED											

NOTE: Contact factory for non-specified capacitance values